

Abstract

Method of transferring thin films

The present invention discloses a method for transferring a thin film from a first
5 substrate to a second substrate comprising the steps of: providing a transfer structure
and a thin film provided on a surface of a first substrate, the transfer structure
comprising a support layer and a film contact layer, wherein the transfer structure
contacts the thin film; removing the first substrate to obtain the transfer structure with
the thin film in contact with the film contact layer; contacting the transfer structure
10 obtained with a surface of a second substrate; and removing the film contact layer,
thereby transferring the thin film onto the surface of the second substrate.

(Figure 1(A))